

## CMOS 16-bit Single Chip Microcontroller

- Low Power MCU (operating voltage 1.8 V, 0.5  $\mu$ A/SLEEP, 2.5  $\mu$ A/HALT)
- S1C17 High Performance 16-bit RISC CPU Core with C Optimized Compact Code and Serial ICE Support
- Infrared Remote Controller with Carrier Generator
- 32K-Byte ROM and 2K-Byte RAM

### DESCRIPTIONS

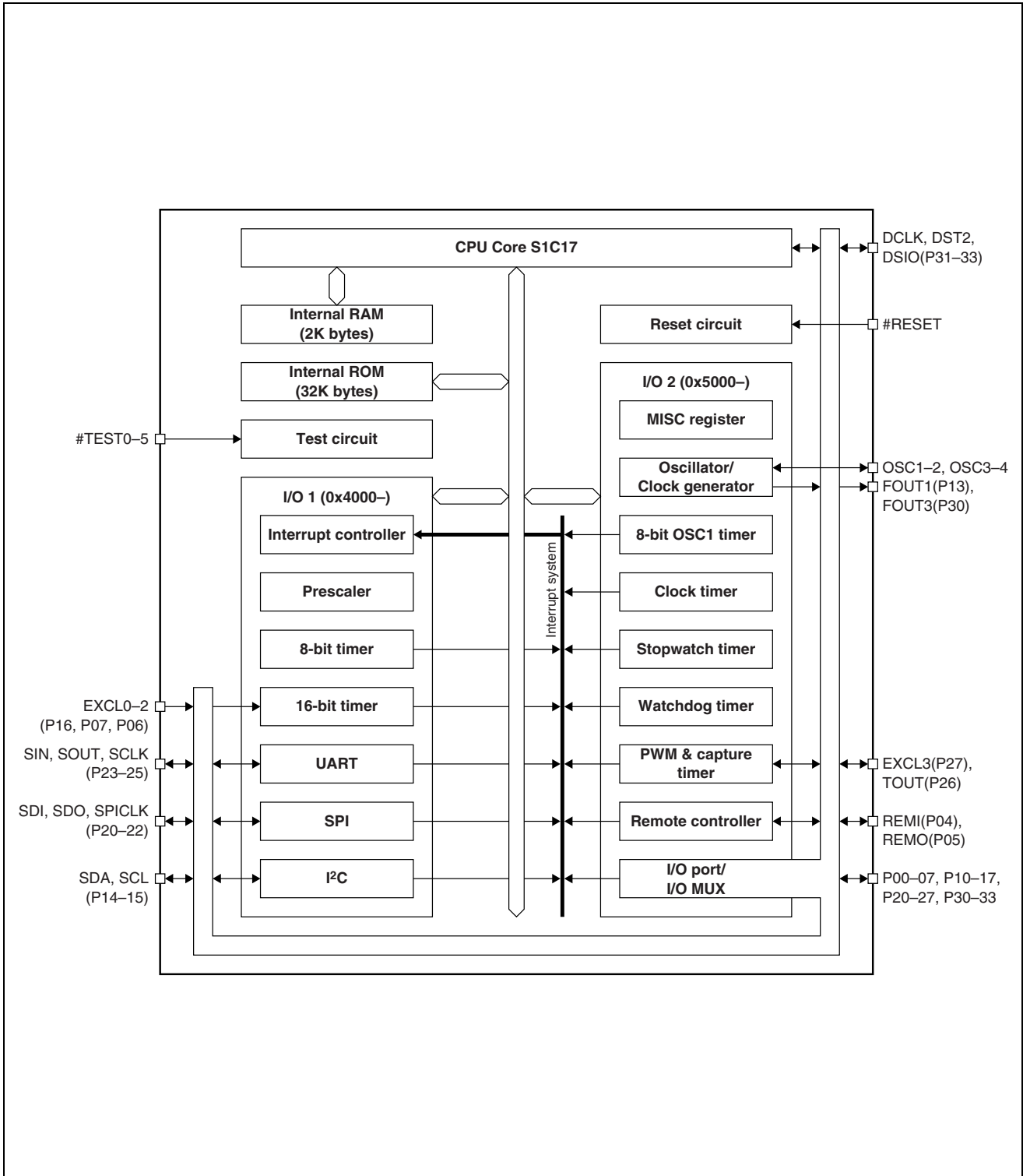
The S1C17001 is a 16-bit MCU that features high-speed operation, low power consumption, small size, large address space, and on-chip ICE. The S1C17001 consists of an S1C17 CPU Core, a 32K-byte ROM, a 2K-byte RAM, serial interface modules (UART that supports high bit rate and IrDA 1.0, SPI and I<sup>2</sup>C) for connecting various sensor modules, 8-bit timers, 16-bit timers, a PWM & capture timer, a clock timer, a stopwatch timer, a watchdog timer and 28 GPIO ports. The S1C17001 is capable of high-speed operation (8.2 MHz) with low operating voltage (1.8 V). Its 16-bit RISC processor executes one instruction in one clock cycle. The S1C17001 also provides an on-chip ICE function that allows on-board debugging and evaluating the program by connecting the S1C17001 to the ICD Mini (S5U1C17001H) or ICD board with only three wires.

### FEATURES

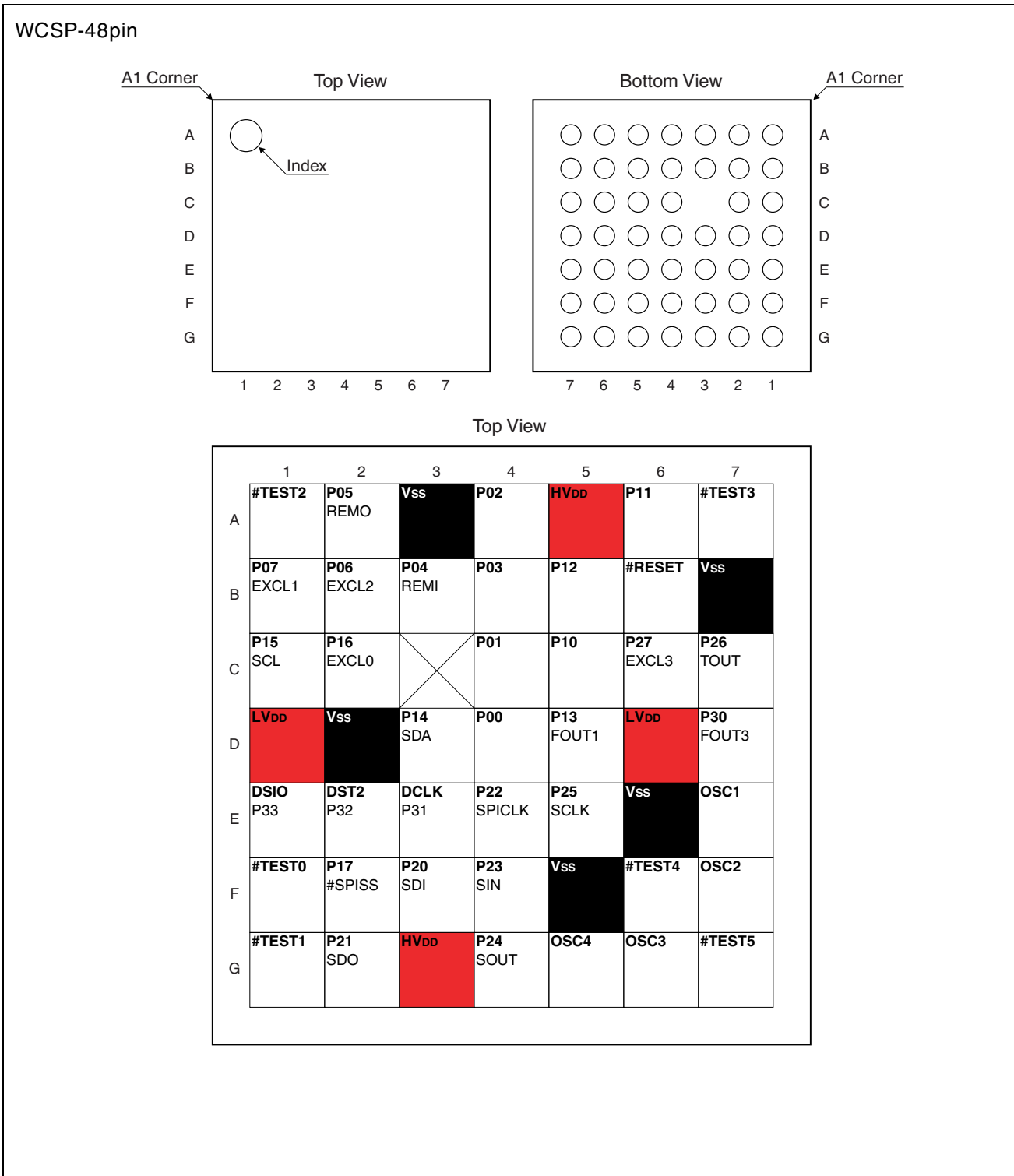
- CPU ..... • Seiko Epson original 16-bit RISC CPU core S1C17
- Main (OSC3) oscillator ..... • Crystal/ceramic oscillator or external clock input 8.2 MHz (max.)
- Sub (OSC1) oscillator..... • Crystal oscillator or external clock input 32.768 kHz (typ.)
- On-chip ROM..... • 32K bytes
- On-chip RAM..... • 2K bytes
- I/O ports ..... • Max. 28 general-purpose I/O ports (Pins are shared with the peripheral I/O.)
- Serial interfaces.....
  - SPI (master/slave) 1 ch.
  - I<sup>2</sup>C (master) 1 ch.
  - UART (with IrDA 1.0) 1 ch.
  - Remote controller (REMC) 1 ch.
- Timers.....
  - 8-bit timer (T8F) 1 ch.
  - 16-bit timer (T16) 3 ch.
  - PWM & capture timer (T16E) 1 ch.
  - Clock timer (CT) 1 ch.
  - Stopwatch timer (SWT) 1 ch.
  - Watchdog timer (WDT) 1 ch.
  - 8-bit OSC1 timer (T8OSC1) 1 ch.
- Interrupts .....
  - Reset
  - NMI
  - 14 hardware interrupts (8 levels)
- Power supply voltage.....
  - Core voltage (LVDD) 1.65 V to 2.7 V
  - I/O voltage (HVDD) 1.65 V to 3.6 V
- Operating temperature ..... • -40°C to 85°C
- Current consumption (typ.).....
  - SLEEP state: 0.5  $\mu$ A
  - HALT state: 2.5  $\mu$ A (32 kHz)
  - Run state: 10  $\mu$ A (32 kHz)
  - 1800  $\mu$ A (8 MHz)
- Shipping form ..... • WCSP-48pin plastic package
- Flash memory model for developing mask ROM code..... • S1C17704

# S1C17001

## ■ BLOCK DIAGRAM



## PIN LAYOUT DIAGRAM



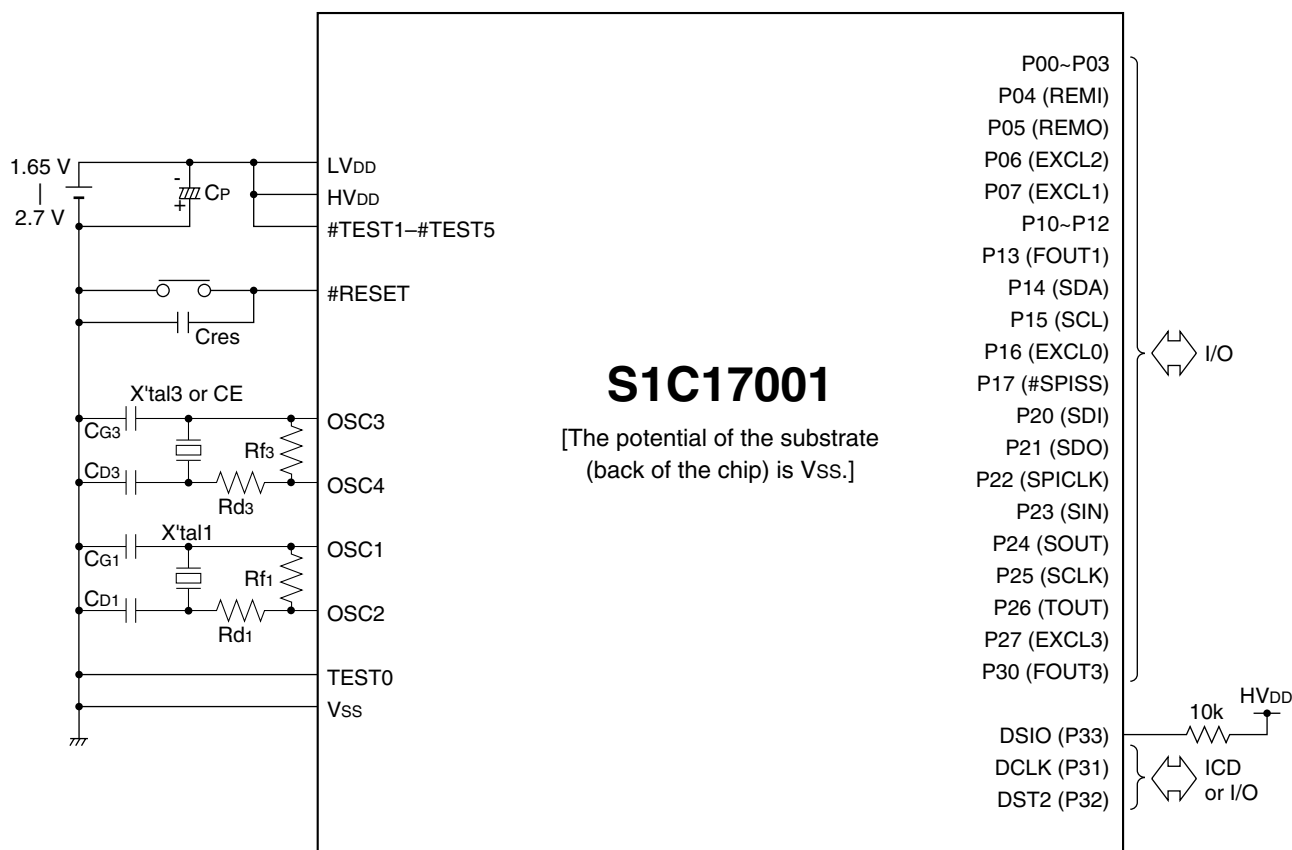
## ■ PIN DESCRIPTION

No.	Pin name	I/O	Initial	Function
1	<b>Vss</b>	–	–	Power supply pin (GND)
2	<b>#TEST1</b>	I	I (Pull-UP)	Test pin (fix at high during normal operation)
3	<b>#TEST2</b>	I	I (Pull-UP)	Test pin (fix at high during normal operation)
4	<b>#TEST3</b>	I	I (Pull-UP)	Test pin (fix at high during normal operation)
5	<b>#TEST4</b>	I	I (Pull-UP)	Test pin (fix at high during normal operation)
6	<b>#TEST5</b>	I	I (Pull-UP)	Test pin (fix at high during normal operation)
7	<b>OSC3</b>	I	I	OSC3 oscillation input pin (external clock may be input)
8	<b>OSC4</b>	O	O	OSC3 oscillation output pin
9	<b>OSC1</b>	I	I	OSC1 oscillation input pin (external clock may be input)
10	<b>OSC2</b>	O	O	OSC1 oscillation output pin
11	<b>HVdd</b>	–	–	Power supply pin (HVDD+)
12	<b>Vss</b>	–	–	Power supply pin (GND)
13	<b>#TEST0</b>	I	I (Pull-UP)	Test pin (fix at high during normal operation)
14	<b>#RESET</b>	I	I (Pull-UP)	Initial reset input pin
15	<b>DSIO/P33</b>	I/O	I (Pull-UP)	On-chip debugger data I/O pin* or I/O port pin
16	<b>DST2/P32</b>	I/O	O (L)	On-chip debugger status output pin* or I/O port pin
17	<b>DCLK/P31</b>	I/O	O (H)	On-chip debugger clock output pin* or I/O port pin
18	<b>P30/FOUT3</b>	I/O	I (Pull-UP)	I/O port pin* or OSC3 divider clock output pin
19	<b>P27/EXCL3</b>	I/O	I (Pull-UP)	I/O port pin* or T16E external clock input pin
20	<b>P26/TOUT</b>	I/O	I (Pull-UP)	I/O port pin* or T16E PWM signal output pin
21	<b>P25/SCLK</b>	I/O	I (Pull-UP)	I/O port pin* or UART clock input pin
22	<b>P24/SOUT</b>	I/O	I (Pull-UP)	I/O port pin* or UART data output pin
23	<b>P23/SIN</b>	I/O	I (Pull-UP)	I/O port pin* or UART data input pin
24	<b>P22/SPICLK</b>	I/O	I (Pull-UP)	I/O port pin* or SPI clock I/O pin
25	<b>P21/SDO</b>	I/O	I (Pull-UP)	I/O port pin* or SPI data output pin
26	<b>P20/SDI</b>	I/O	I (Pull-UP)	I/O port pin* or SPI data input pin
27	<b>P17/#SPISS</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or SPI slave select input pin
28	<b>P16/EXCL0</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or T16 Ch.0 external clock input pin
29	<b>P15/SCL</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or I <sup>2</sup> C clock output pin
30	<b>P14/SDA</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or I <sup>2</sup> C data I/O pin
31	<b>P13/FOUT1</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or OSC1 clock output pin
32	<b>P12</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)
33	<b>P11</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)
34	<b>P10</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)
35	<b>P07/EXCL1</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or T16 Ch.1 external clock input pin
36	<b>P06/EXCL2</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or T16 Ch.2 external clock input pin
37	<b>P05/REMO</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or Remote control signal output pin
38	<b>P04/REMI</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or Remote control signal input pin
39	<b>P03</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)
40	<b>HVdd</b>	–	–	Power supply pin (HVDD+)
41	<b>Vss</b>	–	–	Power supply pin (GND)
42	<b>P02</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)
43	<b>P01</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)
44	<b>P00</b>	I/O	I (Pull-UP)	I/O port pin (with interrupt)
45	<b>LVdd</b>	–	–	Power supply pin (LVDD+)
46	<b>Vss</b>	–	–	Power supply pin (GND)
47	<b>LVdd</b>	–	–	Power supply pin (LVDD+)
48	<b>Vss</b>	–	–	Power supply pin (GND)

Note: The pin names described in boldface type and description with ‘\*’ are default settings.

## ■ BASIC EXTERNAL CONNECTION DIAGRAM

Single power supply system (LVDD = HVDD)



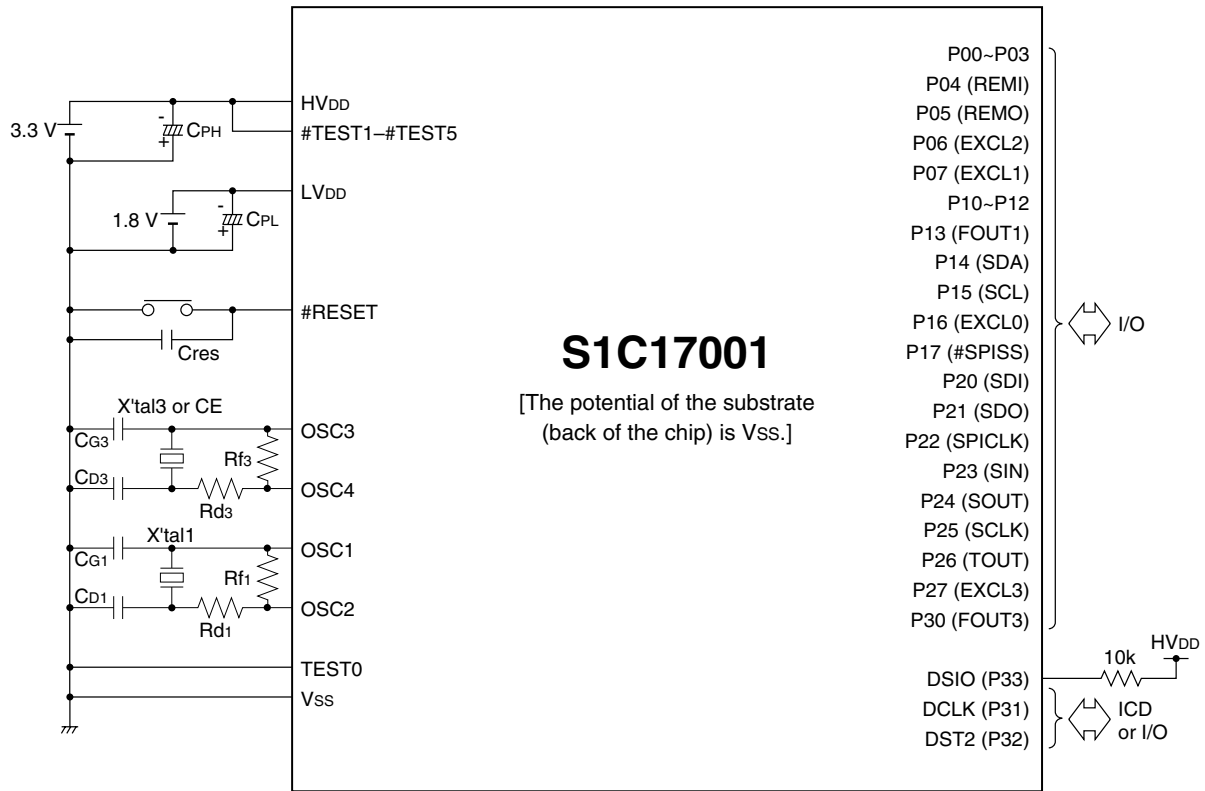
### Recommended values for external parts

Symbol	Name	Recommended value
X'tal1	Crystal oscillator	32.768 kHz (MC-146, EPSON TOYOCOM)
CG1	Gate capacitor	7 pF
CD1	Drain capacitor	7 pF
Rf1	Feedback resistor	10 MΩ
Rd1	Drain resistor	0 Ω
X'tal3	Crystal oscillator	8 MHz (CA-301, EPSON TOYOCOM)
CE	Ceramic oscillator	0.2~8 MHz
CG3	Gate capacitor	27 pF
CD3	Drain capacitor	27 pF
Rf3	Feedback resistor	1 MΩ
Rd3	Drain resistor	0 Ω
CP	Capacitor for power supply	3.3 μF
Cres	Capacitor for #RESET pin	0.47 μF

Note: The above table is simply an example, and is not guaranteed to work.

# S1C17001

Dual-power supply system (LVDD ≠ HVDD)



### Recommended values for external parts

Symbol	Name	Recommended value
X'tal1	Crystal oscillator	32.768 kHz (MC-146, EPSON TOYOCOM)
CG1	Gate capacitor	7 pF
CD1	Drain capacitor	7 pF
Rf1	Feedback resistor	10 MΩ
Rd1	Drain resistor	0 Ω
X'tal3	Crystal oscillator	8 MHz (CA-301, EPSON TOYOCOM)
CE	Ceramic oscillator	0.2-8 MHz
CG3	Gate capacitor	27 pF
CD3	Drain capacitor	27 pF
Rf3	Feedback resistor	1 MΩ
Rd3	Drain resistor	0 Ω
CP	Capacitor for power supply	3.3 μF
Cres	Capacitor for #RESET pin	0.47 μF

Note: The above table is simply an example, and is not guaranteed to work.

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